



#### 30V N-CHANNEL ENHANCEMENT MODE MOSFET

#### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
	$5.5$ m $\Omega$ @ $V_{GS} = 10$ V	15A
30V	$7.5 \text{m}\Omega$ @ $V_{GS} = 4.5 \text{V}$	12A

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Motor Control
- Backlighting
- Power Management Functions
- DC-DC Converters

## **Features and Benefits**

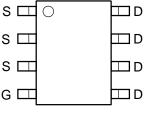
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

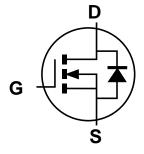
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Connections Indicator: See Diagram Below
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.074 grams (Approximate)



Top View



Top View Internal Schematic



Equivalent Circuit

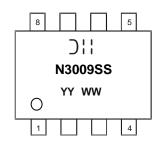
#### **Ordering Information** (Note 4)

Part Number	Case	Packaging	
DMN3009SSS-13	SO-8	2500/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# Marking Information



⊃¦¦ = Manufacturer's Marking N3009SS = Product Type Marking Code YYWW = Date Code Marking YY or YY = Year (ex: 19 = 2019) WW = Week (01 to 53)



# 

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	$V_{DSS}$	30	V		
Gate-Source Voltage	V <sub>GSS</sub>	±20	V		
Continuous Drain Current (Note 6) $V_{GS} = 10V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			I <sub>D</sub>	15 12	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	80	Α		
Maximum Continuous Body Diode Forward Current (	Is	2.7	Α		
Avalanche Current (Note 7) L = 0.1mH	I <sub>AS</sub>	33	Α		
Avalanche Energy (Note 7) L = 0.1mH	Eas	55	mJ		

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Total Power Dissipation (Note 5) Steady State		$T_A = +25^{\circ}C$	$P_D$	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>ÐJA</sub>	101	°C/W	
Total Power Dissipation (Note 6) Steady State		$T_A = +25^{\circ}C$	$P_D$	1.8	W
Thermal Resistance, Junction to Ambient (Note 6)			R <sub>ÐJA</sub>	73	°C/W
Thermal Resistance, Junction to Case (Note 6)			Rejc	7.6	C/VV
Operating and Storage Temperature Range			T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	1.5	2.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	4.5	5.5	mΩ	$V_{GS} = 10V, I_D = 15A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	5.5	7.5		$V_{GS} = 4.5V, I_D = 15A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.75	1.2	V	$V_{GS} = 0V$ , $I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	_	2,000	_	рF	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
Output Capacitance	Coss	_	315	_	рF	$V_{DS} = 15V, V_{GS} = 0V,$ -f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	247	_	pF	1 - 1.01/11/12	
Gate Resistance	Rg	_	2.2	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	20	_	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	42	_	nC	\/ 45\/ L 45A	
Gate-Source Charge	Qgs	_	4.7	_	nC	$V_{DS} = 15V, I_{D} = 15A$	
Gate-Drain Charge	Q <sub>gd</sub>	_	7.4	_	nC	1	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.9	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	4.1	_	ns	$V_{DD} = 15V, V_{GS} = 10V,$ $R_G = 3.3\Omega, I_D = 15A$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	31	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	15	_	ns		
Reverse Recovery Time	t <sub>RR</sub>	_	15	_	ns	154 174 1004	
Reverse Recovery Charge	Q <sub>RR</sub>	_	6.0	_	nC	I <sub>F</sub> = 15A, di/dt = 100A/μs	

Notes:

- 5. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
- I<sub>AS</sub> and E<sub>AS</sub> ratings are based on low frequency and duty cycles to keep T<sub>J</sub> = +25°C.
  Short duration pulse test used to minimize self-heating effect.
  Guaranteed by design. Not subject to product testing.



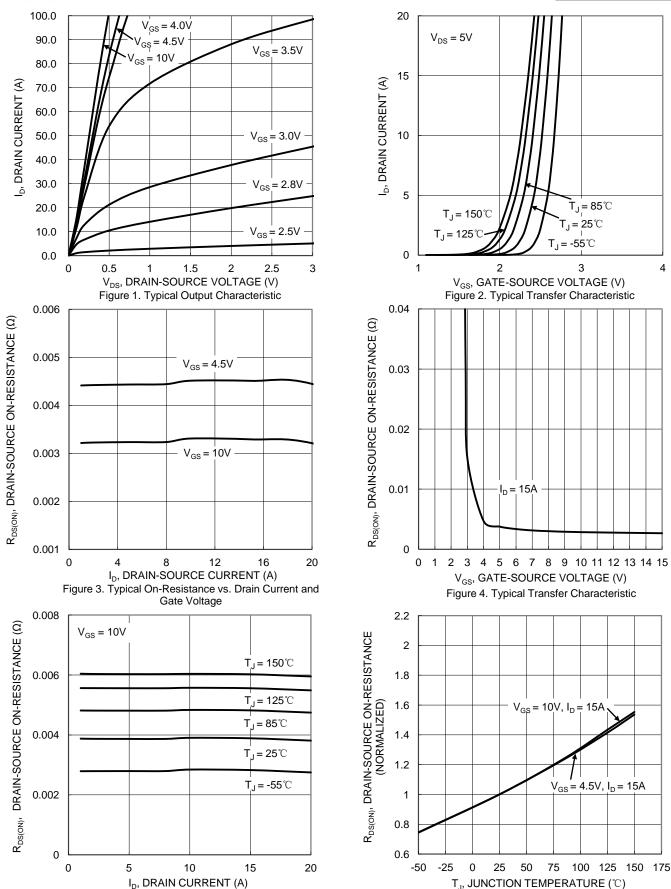


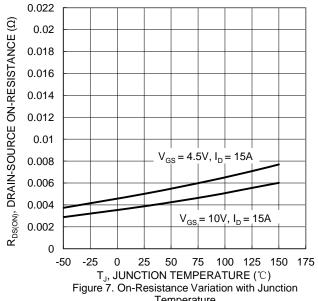
Figure 5. Typical On-Resistance vs. Drain Current

and Junction Temperature

Figure 6. On-Resistance Variation with Junction

Temperature





Temperature

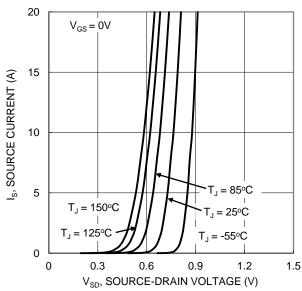
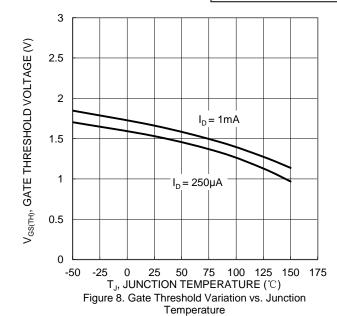
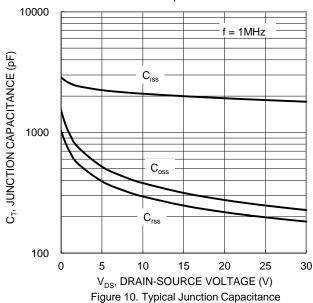
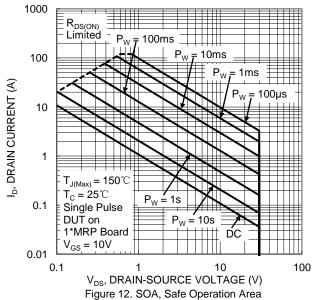


Figure 9. Diode Forward Voltage vs. Current 10 8 6  $V_{GS}(V)$ 4  $V_{DS} = 15V, I_{D} = 15A$ 2 0 5 10 15 20 25 30 35 40 45 0  $Q_q(nC)$ 

Figure 11. Gate Charge









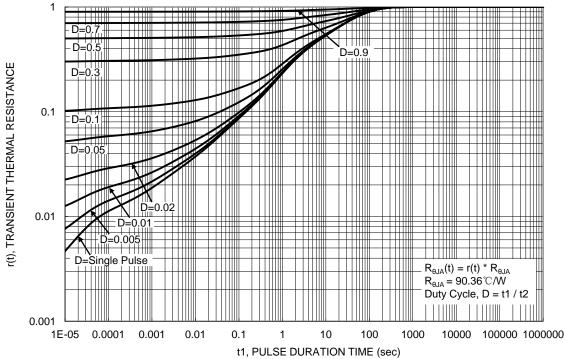


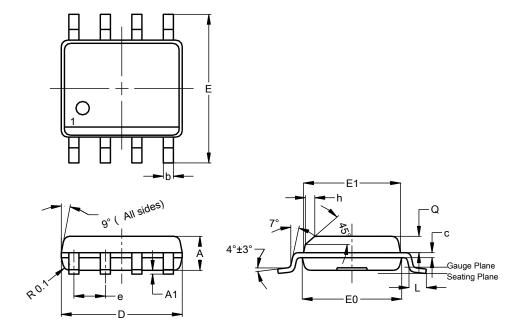
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8

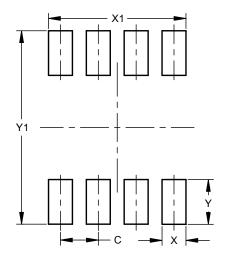


SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
С	0.15	0.25	0.20			
D	4.85	4.95	4.90			
Е	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
е			1.27			
h			0.35			
L	0.62	0.82	0.72			
Q	0.60	0.70	0.65			
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



Dimensions	Value (in mm)			
С	1.27			
Х	0.802			
X1	4.612			
Y	1.505			
Y1	6.50			

August 2019



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